



## Features

- 3rd Gen Intel® Core™ i7/i5/i3 / Xeon® processors
- 8x PCI-E GbE ports
- 4x DDR3 DIMM; Max. 32 GB
- 1x CFAST socket, 1x CF slot, 1x Mini PCI-E (mSATA compatible) socket
- iAMT 8.0 support

## Specifications

CPU	LGA1155 socket for 3rd Gen Intel® Core™ i7/i5/i3/Xeon® processors
Chipset	Intel® C216 PCH
Memory	4x DDR3 DIMMs up to 1600MHz, Max. 32GB UDIMM (ECC or non-ECC)
Display	Supports VGA via pin header
Ethernet	1x Intel® 82579LM GbE PHY w/ iAMT 8.0 support 7x Intel® 82583V GbE
Bypass	2x segment, LAN 5/6 & 7/8
Expansion	2x PCI-E x8 GF, 1x Mini PCI-E slot (SATA signal)
IPMI	N/A
Storage	2x SATA III ports 1x CF slot 1x CFAST slot
I/O	3x LED (Power / HDD / Status) 1x Factory default button (GPIO) 1x RJ45 console 2x USB 3.0
Power Input	ATX Power
Dimensions	355 mm x 185 mm (13.98" x 7.28")
Operating Temperature	0°C ~ 60°C (32°F~140°F)
Storage Temperature	-20°C ~ 80°C (-4°F~176°F)
Operating Humidity	10% ~ 90% (non-condensing)
Certification	CE/FCC

## Ordering Information

MB967	Networking motherboard for 3rd Gen Intel® Xeon® / Core™ i7/i5/i3 socket, C216 PCH, 4x DDR3 DIMMs, 8x GbE Port, Barebone without CPU/Cooler/RAM
VGA4	VGA cable
USB2-7	Dual port USB 2.0 cable, 300mm
IP331	1-to-1 PCI-E 8x riser card
IP332	PCI-E 8x adapter card
IP333	2-to-2 PCI-E 8x riser card